

HSF

NOTES:

Current Rating: 5.0AMP

Contact Resistance: 10mΩ Max

Withstand Voltage: 1500V AC/DC

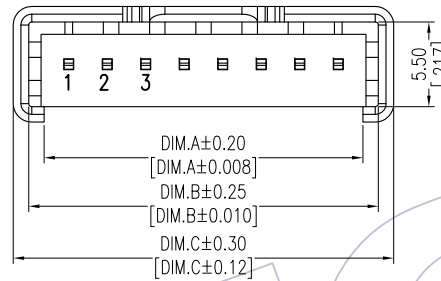
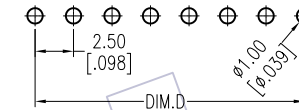
Insulation Resistance: 1000MΩ Min

Operation Temperature: -40℃ to +105℃

Contact Material: Brass

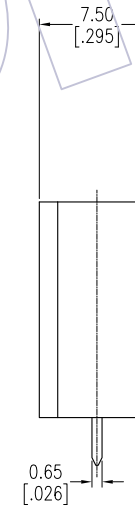
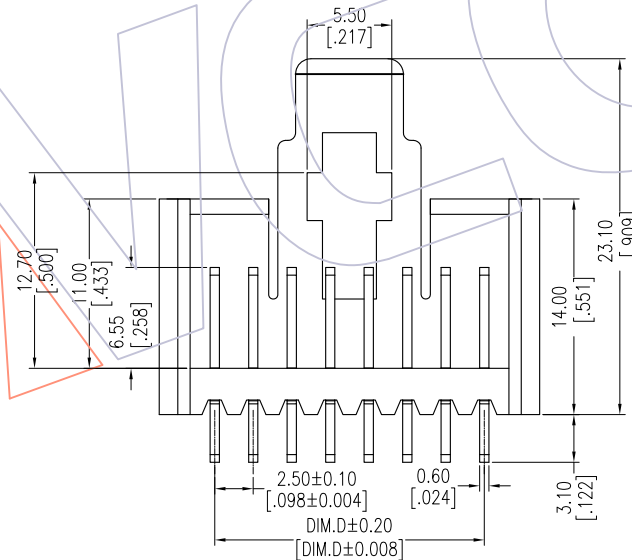
Contact plating: Matte Sn over Ni

Insulator Material: PBT+30%G.F UL94V-0

Recommended P.C.B Layout (Top Side)
(PCB BOARD TOLERANCE±0.05)

Ordering Information

WF2512-WS XX G 0 2

No. of pins
02~20PColor
G-GreyPacking
0=PE Bag

PIN	DIM.A	DIM.B	DIM.C	DIM.D
2P	5.70	7.70	9.70	2.50
3P	8.20	10.20	12.20	5.00
4P	10.70	12.70	14.70	7.50
5P	13.20	15.20	17.20	10.00
6P	15.70	17.70	19.70	12.50
7P	18.20	20.20	22.20	15.00
8P	20.70	22.70	24.70	17.50
9P	23.20	25.20	27.20	20.00
10P	25.70	27.70	29.70	22.50
11P	28.20	30.20	32.20	25.00
12P	30.70	32.70	34.70	27.50
13P	33.20	35.20	37.20	30.00
14P	35.70	37.70	39.70	32.50
15P	38.20	40.20	42.20	35.00
16P	40.70	42.70	44.70	37.50
17P	43.20	45.20	47.20	40.00
18P	45.70	47.70	49.70	42.50
19P	48.20	50.20	52.20	45.00
20P	50.70	52.70	54.70	47.50

				OPERATION		DRAW JYHuang	DATE 2014/11/10	SCALE UNIT	FIT mm	PART NO. WF2512-WSXXG02	
				X.X	±0.40					TITLE:	
				X.XX	±0.25					2.50mm Pitch Wafer 180° With Latch	
				X.XXX	±0.15	APPROVE	DATE	SHEET 1/1	PROJ.	Customer NO.	
AO	2014/11/10	NEW	-----	Angle	± 3'						
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL						